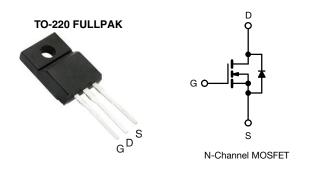
IRLI520G

Vishay Siliconix



Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V)	100)
R _{DS(on)} (Ω)	$V_{GS} = 5 V$	0.27
Q _g (Max.) (nC)	12	
Q _{gs} (nC)	3.0	
Q _{gd} (nC)	7.1	
Configuration	Sing	le

FEATURES

- Isolated package
- High voltage isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to lead creepage distance = 4.8 mm
- Logic-level gate drive
- $R_{DS (on)}$ specified at $V_{GS} = 4$ V and 5 V
- Fast switching
- · Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRLI520GPbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	100	v	
Gate-source voltage		V _{GS}	± 10			
Continuous drain current	$T_{\rm C} = 25 ^{\circ}{\rm C}$			7.2		
		T _C = 100 °C	I _D	5.1	Α	
Pulsed drain current ^a			I _{DM}	29		
Linear derating factor				0.24	W/°C	
Single pulse avalanche energy b			E _{AS}	170	mJ	
Repetitive avalanche current ^a			I _{AR}	7.2	Α	
Repetitive avalanche energy ^a			E _{AR}	3.7	mJ	
Maximum power dissipation $T_{C} = 25 \text{ °C}$		25 °C	PD	37	W	
Peak diode recovery dV/dt ^c		dV/dt	5.5	V/ns		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C		
Soldering recommendations (peak temperature) ^d	For	10 s		300 ^d		
Mounting torque	M3 s	screw		0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 4.9 mH, R_G = 25 Ω , I_{AS} = 7.2 A (see fig. 12)

c. $I_{SD} \leq 9.2$ A, dI/dt ≤ 110 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^\circ C$

d. 1.6 mm from case

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PARAMETER	SYMBOL	TYP		MAX.			UNIT		
Maximum junction-to-ambient	R _{thJA}	-	-	65					
Maximum junction-to-case (drain)	R _{thJC}	-		4.1		-	°C/W		
SPECIFICATIONS T _J = 25 °C, u	nless otherwi	se noted							
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static		•			•	•	•		
Drain-ssource breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	100	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.12	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	50 µA	1.0	-	2.0	V	
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 10^{\circ}$	V	-	-	± 100	nA	
		V _{DS} =	= 100 V, V _{GS}	= 0 V	-	-	25	1	
Zero gate voltage drain current	IDSS	V _{DS} = 80 V	V _{GS} = 0 V,	T _J = 150 °C	-	-	250	μA	
	6	$V_{GS} = 5 V$	I _D	= 4.3 A ^b	-	-	0.27		
Drain-source on-state resistance	R _{DS (on)}	$V_{GS} = 4 V$	I _D	= 3.6 A ^b	-	-	0.38	Ω	
Forward transconductance	9 _{fs}	V _{DS} =	= 50 V, I _D = -	4.3 A ^b	3.3	-	-	S	
Dynamic		•							
Input capacitance	C _{iss}	N 0.1		-	490	-			
Output capacitance	C _{oss}		V _{GS} = 0 V, V _{DS} = 25 V,		-	150	-	1_	
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	30	-	pF		
Drain to sink capacitance	С		f = 1.0 MHz	2	-	12	-		
Total gate charge	Qg				-	-	12		
Gate-source charge	Q _{gs}	V _{GS} = 5 V		A, V _{DS} = 80 V, J. 6 and 13 ^b	-	-	3.0	nC	
Gate-drain charge	Q _{gd}		566 H	J. O and 15	-	-	7.1		
Turn-on delay time	t _{d(on)}		1		-	9.8	-		
Rise time	t _r		= 50 V, I _D =		-	64	-		
Turn-off delay time	t _{d(off)}	- R _G =	= 9 Ω _, R _D = 5 see fig. 10 ^t		-	21	-	ns	
Fall time	t _f			-	27	-	1		
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-			
Internal source inductance	Ls			-	7.5	-	- nH		
Drain-Source Body Diode Characteristic	cs				1	<u> </u>	I		
Continuous source-drain diode current	I _S	MOSFET sym showing the			-	-	7.2	А	
Pulsed diode forward current ^a	I _{SM}	integral revers p - n junction			-	-	29	~	
Body diode voltage	V_{SD}	T _J = 25 °C	, I _S = 7.2 A,	$V_{GS} = 0 V^{b}$	-	-	2.5	V	
Body diode reverse recovery time	t _{rr}	T 25 °C I	سه ۵۵۸ –	dt - 100 A (uch	-	130	190	ns	
Body diode reverse recovery charge	Q _{rr}	$I_{\rm J} = 25^{-1} \rm C, I_{\rm F}$	= 9.2 A, dl/	dt = 100 A/µs ^b	-	0.83	1.0	μC	
Franciscul Association (Sec.)	+	linduite of a l		a nagligituta (t					

Forward turn-on time ton Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 $\,\%$

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

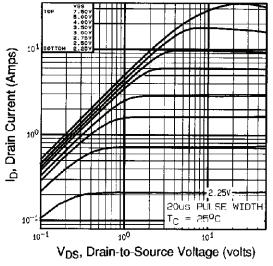


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

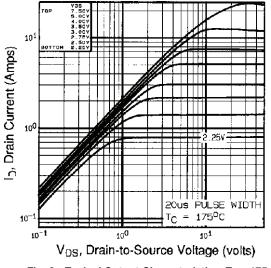
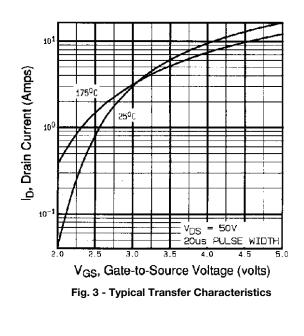


Fig. 2 - Typical Output Characteristics, T_C = 175 °C



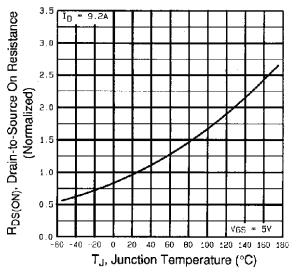


Fig. 4 - Normalized On-Resistance vs. Temperature



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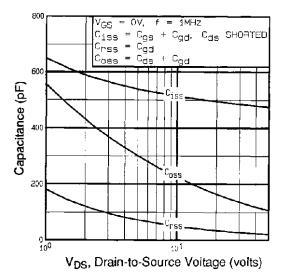


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

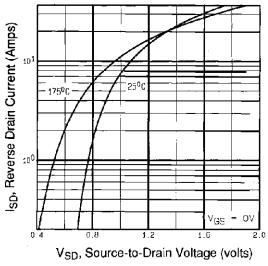


Fig. 7 - Typical Source-Drain Diode Forward Voltage

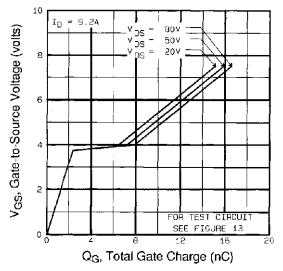
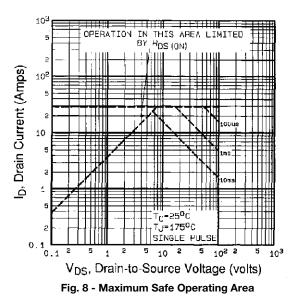


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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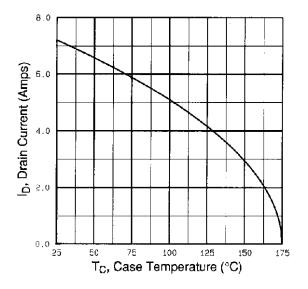


Fig. 9 - Maximum Drain Current vs. Case Temperature

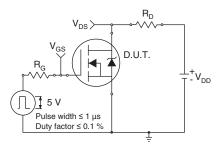


Fig. 10a - Switching Time Test Circuit

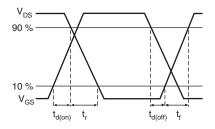
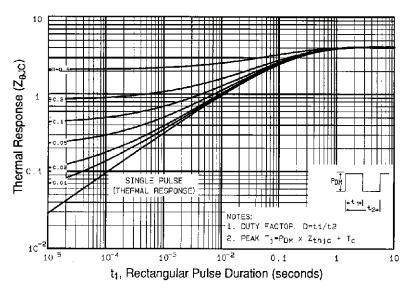


Fig. 10b - Switching Time Waveforms





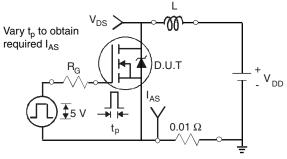
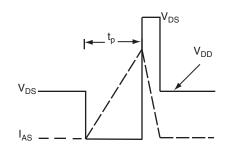
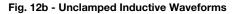


Fig. 12a - Unclamped Inductive Test Circuit





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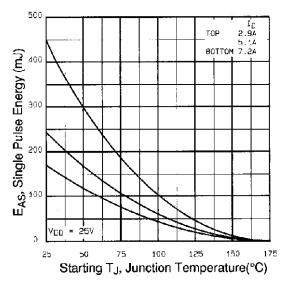


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

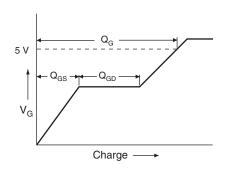


Fig. 13a - Basic Gate Charge Waveform

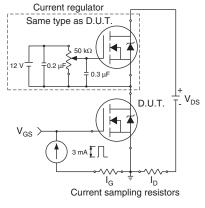
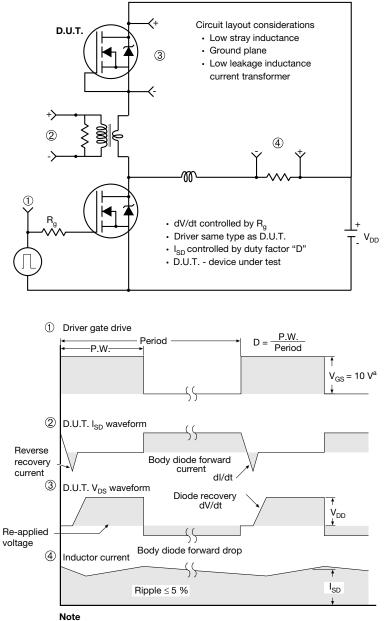


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig.14 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS				
DIM.	MIN.	NOM.	MAX.			
A	4.60	4.70	4.80			
b	0.70	0.80	0.91			
b1	1.20	1.30	1.47			
b2	1.10	1.20	1.30			
С	0.45	0.50	0.63			
D	15.80	15.87	15.97			
е	2.54 BSC					
E	10.00	10.10	10.30			
F	2.44	2.54	2.64			
G	6.50	6.70	6.90			
L	12.90	13.10	13.30			
L1	3.13	3.23	3.33			
Q	2.65	2.75	2.85			
Q1	3.20	3.30	3.40			
ØR	3.08	3.18	3.28			

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
E	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100) BSC
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØP	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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